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**UPDATE CHANGE NOTIFICATION**

Generic Copy

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**20 Feb 2008**

**SUBJECT: ON Semiconductor Update Notification #16102**

**TITLE: Final Notification if ISMF Wafer Fab Qualification for Schottky Rectifier Products**

**PROPOSED FIRST SHIP DATE: 18 Mar 2008**

**AFFECTED CHANGE CATEGORY(S): ON Semiconductor Fab Site**

**AFFECTED PRODUCT DIVISION(S): Automotive & Power Regulation Group**

**ADDITIONAL RELIABILITY DATA: N/A**

**SAMPLES: N/A**

**FOR ANY QUESTIONS CONCERNING THIS NOTIFICATION:**

Contact your local ON Semiconductor Sales Office or Mark Thomas<[Mark.Thomas@onsemi.com](mailto:Mark.Thomas@onsemi.com)>

**NOTIFICATION TYPE:**

ON Semiconductor will consider this change approved unless specific conditions of acceptance are provided in writing within 30 days of receipt of this notice. To do so, contact your local ON Semiconductor Sales Office.

**DESCRIPTION AND PURPOSE:**

This is an update to FPCN 16077 that announced ON Semiconductor is adding wafer fabrication capacity for Schottky Rectifier products at our ISMF wafer fab in Seremban, Malaysia.

The following list of devices should not have been included in FPCN 16077, and are therefore excluded from the change.



**Update Notification #16102**

**AFFECTED DEVICE LIST**

MBR1045  
MBR10H100CT  
MBR1535CT  
MBR1545CT  
MBR16100CT  
MBR1635  
MBR1645  
MBR20100CT  
MBR2045CT  
MBR2080CT  
MBR20H100CT  
MBR2535CT  
MBR2545CT  
MBR3045PT  
MBR3045ST  
MBR30H100CT  
MBR4045PT  
MBR4045WT  
MBR41H100CT  
MBR6045PT  
MBR6045WT  
MBR60H100CT  
MBR7030WT  
MBR735  
MBR745  
MBRB1045  
MBRB1545CT  
MBRB2545CT  
MBRB2545CTT4  
MBRB3030CT  
MBRB3030CTT4  
MBRB4030  
MBRB4030T4  
MBRM120ET1  
MBRM120ET3